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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/891,730	06/25/2001	Steven Verhaverbeke	004990	1392
32588	7590 04/22/2004		EXAMINER	
APPLIED MATERIALS, INC.			UMEZ ERONINI, LYNETTE T	
	SBLVD. M/S 2061 ARA, CA 95050		ART UNIT	PAPER NUMBER
0111(111 021)			1765	

DATE MAILED: 04/22/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

•	Application No.	Applicant(s)
	09/891,730	VERHAVERBEKE ET AL.
Office Action Summary	Examiner	Art Unit
·	Lynette T. Umez-Eronini	1765
The MAILING DATE of this communication Period for Reply	appears on the cover sheet with the	correspondence address
A SHORTENED STATUTORY PERIOD FOR RE THE MAILING DATE OF THIS COMMUNICATIO - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, - If NO period for reply is specified above, the maximum statutory per - Failure to reply within the set or extended period for reply will, by state Any reply received by the Office later than three months after the meanned patent term adjustment. See 37 CFR 1.704(b).	N. R. 1.136(a). In no event, however, may a reply be to the control of the contro	imely filed ys will be considered timely. m the mailing date of this communication. ED (35 U.S.C. § 133).
Status		•
1) Responsive to communication(s) filed on 30 2a) This action is FINAL . 2b) 7 3) Since this application is in condition for allo closed in accordance with the practice under	This action is non-final. wance except for formal matters, p	
Disposition of Claims		
4) Claim(s) 1-13,15-23,41-53,56-96,100,102,1 4a) Of the above claim(s) is/are without significant of the above claim(s) is/are without significant of the above claim(s) is/are without significant of the above claim(s) is/as objected to. 8) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and significant of the above claim(s) are subject to by the Examplication Papers 9) The specification is objected to by the Examplicant may not request that any objection to Replacement drawing sheet(s) including the coresponding to the above claim(s) is/are: a)	drawn from consideration. d 112 is/are allowed. 4,106 and 108-110 is/are rejected. d/or election requirement. hiner. accepted or b) objected to by the drawing(s) be held in abeyance. Sometime is required if the drawing(s) is or	e Examiner. ee 37 CFR 1.85(a). bjected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119	•	•
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority docum 2. Certified copies of the priority docum 3. Copies of the certified copies of the priority docum application from the International But * See the attached detailed Office action for a	nents have been received. Idents have been received in Applications Identify documents have been received (PCT Rule 17.2(a)).	ntion No ved in this National Stage
Attachment(s)		(DTO 442)
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB Paper No(s)/Mail Date 		ry (PTO-413) Date Patent Application (PTO-152)

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DETAILED ACTION

Claim Objections

1. Claims 1 and 104 are objected to because of the following informalities:

In claim 1, the long-hand name for "EDDHA" is not written; and

In claim 104, "triethylenetetranitrilohexaacettic" is misspelled. Appropriate correction is required.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 4. Claims 1-13 and 104 are rejected under 35 U.S.C. 103(a) as being unpatentable over Liu et al. (US 4,817,652) in view of Morinaga et al. (US 5,885,362).

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Liu teaches, "Centrifugal spray cleaning is an effective cleaning alternative to chemical immersion processes . . . As the wafers spin, they are subjected to a series of continuous fine sprays of reagent solution, including a hot aqueous solution of hydrogen peroxide and ammonium hydroxide, . . . and high purity water, which reads on,

A method of processing a wafer comprising: placing a wafer in a single wafer cleaning tool; spinning said wafer in said single wafer cleaning tool and while spinning said wafer; after placing said wafer in said single wafer cleaning tool, exposing said wafer to a solution comprising: H_2O_2 , NH_4OH ; and H_2O .

Liu differs in failing to teach exposing the wafer to a chelating agent, comprising: EDDHA, in claim 1; and

triethylenetetranitrilohexaacetic acid (TTHA), in claim 104.

Morinaga teaches a surface treatment (cleaning) composition, which comprises aqueous ammonia (same as applicants' NH₄OH), hydrogen peroxide, and water, and a complexing agent such as EDDHA and TTHA, (column 14, line 66 - column 15, line 4; column 4, line 1-5 and 54-57; and column 7, lines 49-50).

It would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify Liu's cleaning solution by adding EDDHA or TTHA, as taught by Morinaga's for the purpose of preventing metal impurities from being deposited on a substrate surface (Morinaga, column 3, lines 5-11).

5. Claims 106 and 108-110 and are rejected under 35 U.S.C. 103(a) as being unpatentable over Lin as in view of Hayashida et al. (US 5,840,127).

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Liu differs in failing to teach cleaning the wafer with desferriferrixmin B., in claim 106 and BAMTH, in claim 108.

Hayashida teaches treating solutions prepared by adding N,N',N"-tris[2-(N-hydroxycarbamoyl)ethyl]-1,3,5-benzenetricarboxamide (same as applicants' BAMTH) (BAMTPH) or desferrioxamine B (same as applicants' desferriferrixmin B.) to SC-1 treating (Standard Clean 1 solution consists of a mixture of NH₄OH, H₂O₂, and H₂O) solution (column 11, lines 12-21; Tables 1 and 3; and column 6, lines 14-23, 55-59).

It would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify Liu's cleaning solution by adding desferriferrixmin B and BAMTPH, as taught by Hayashida for the purpose of improving surface treating process, which prevents Al contamination caused by adsorption from a treating and which have a high cleaning efficiency metal impurities from being deposited on a substrate surface (Hayashida, column 3, lines 36-41).

6. Claims 15-23 are rejected under 35 U.S.C. 103(a) as being unpatentable over Liu (US '652) in view of Morinaga (US '362) as applied to claim 1 above, and further in view of Olesen et al. (US 5,996,595).

Liu in view of Morinaga differs in failing to teach the solution comprises a surfactant as recited in claims 15-23.

Olesen shows a surfactant is introduced with DI water, NH_4OH , and H_2O_2 in Figure 4 (column 8, lines 44-45).

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It is the examiner's position that it would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify Liu in view of Morinaga by adding a surfactant, as taught by Olesen for the purpose of protecting the wafer from NH₄OH and reducing the surface tension of DI water (Olesen, column 8, lines 53-54).

Claim Rejections - 35 USC § 102

7. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

8. Claims 52, 53, and 56-58 are rejected under 35 U.S.C. 102(b) as being anticipated by Ban et al. (US 5,470,461).

Ban teaches, "... After that, deionized water is produced by a two-bed ion exchange pure water producing apparatus 121 with a degasifier. Subsequently, ozone is added to the deionized water and reaction there between is effected in a reaction vessel 122..." (column 10, lines 40-49). Since Ban uses the same steps in processing water as those claimed by the applicants, then using Ban's method of processing water would inherently result in a method of forming a rinse and further reads on, the said method comprising:

degassing H₂O; and

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dissolving a gaseous oxidant comprising O_3 in to said H_2O .

Claim Rejections - 35 USC § 103

9. Claims 67-78 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lin et al. (US 6,063,695)

Lin teaches etching a wafer with an etchant that comprises HF and for a period of time that is experimentally determined. In the present embodiment, the time period is between about 8 and 14 minutes and after this time period the etchant is quenched by rinsing the wafer 10 with de-ionized water (column 4, lines 4-2) which reads on,

A method of processing a wafer comprising: placing said wafer in a single wafer cleaning tool; after placing said wafer in said single wafer cleaning tool, dispensing an HF solution on said wafer, dispensing a cleaning solution on said wafer immediately after dispensing said HF solution to neutralize said HF solution.

Lin differs in failing to recite dispensing an HF solution on the wafer for between 2-3 seconds, **in claim 67**.

It would have been obvious to one having ordinary skill in the art at the time of the claimed invention to use any range of times in dispensing HF solution on the wafer as disclosed by the Lin reference, including using the range of times as claimed by the applicants for the purpose of quenching the etching process (Lin, column 4, lines 19-20.

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Allowable Subject Matter

- 10. Claims 41-51; 59-66; 79-96; 100; 102; and 112 are allowed.
- 11. The following is a statement of reasons for the indication of allowable subject matter: As to claims 41-51; 59-66; 79-96; 100; 102; and 112, the prior art of record, taken either alone or in combination, fails to disclose or render obvious:

the sequence of steps in cleaning a wafer, in claims 41-51, 59-66, 79-96, and 100;

cleaning a wafer with N,N'-Bis(2-hydroxyphenyl)ethylenediiminodiacetic acid (HPED), in claim 102; and

cleaning a wafer with molybdic acid, in claim 112, in combination with the rest of the limitation of the above claims.

Response to Arguments

12. Applicant's arguments with respect to claims 1-13, 15-23, 41-53, 56-96, 100, 102, 104, 106, 108-112 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

13. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

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A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Lynette T. Umez-Eronini whose telephone number is 571-272-1470. The examiner is normally unavailable on the First Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine Norton can be reached on 571-272-1465. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Itue

April 18, 2004

BUPERVILLE NORTON WINER